

# SHIKUES Low Power Consumption, High Precision, HighESD 1-Cell Li-ion and Li-Polymer Battery Voltage and Current Protection IC

### Description

• SHIKUES battery protection ICs are featured for accurately monitoring Li-ionor Li-Polymer battery voltage and current when charging and discharging the batteries. When over charge, over discharge and short circuit conditions happened, SHIKUES battery protection ICs will control the charging or discharging output pins to control charge or discharge MOSFETsto cut off the charging or discharging path accordingly to protect the batteries frombeing damaged.

• SHIKUES battery protection ICs monitor the charge/discharge/short circuit current by external current sensing resistor, to provide very precise current sensing control.

• SHIKUES battery protection IC embeds with high ESD protection circuit to prevent from ESD issues in mass production and in use.

• SHIKUES battery protection IC power consumption when normal operation is low. For power saving, SHIKUES battery protection IC provides 2 power saving modes : Standby mode and Power Down mode.

### Features

Voltage detection and release

Overcharge Detection Voltage Overcharge Release Voltage Overdischarge Detection Voltage Overdischarge Release Voltage

Current detection and release Discharge Overcurrent Detection Voltage Charge Overcurrent Detection Voltage Load Short-Circuit Detection Voltage

0V Battery Charge Inhibition Battery Voltage

### Operation Modes

Normal Mode	2.5uA (Typ.)	4.0uA (Max.)
Standby Mode	1.0uA (Typ.)	1.5uA (Max.)
Power Down Mode		0.1uA (Max.)

Operation Temperature Range :  $Ta = -40^{\circ}C$  to  $+85^{\circ}C$ 



# Applications

- Smart Phones
- Tablet PCs
- Handheld Data Terminals
- Portable Devices

### Package Type

• DFN 1.6 x 1.6 x 0.75 (mm)

### Pin Assignment



Pin No.	Symbol	Function
1	VM	Input pin for charger negative voltage
2	COUT	Charge FET Gate Drive Output
3	DOUT	Discharge FET Gate Drive Output
4	VSS	Ground
5	VDD	Input pin for positive power supply voltage
6	CS	Overcurrent detection input pin

### Package Outline Drawing







units	MIN.	NOM.	MAX.
SYMBOLS	mm	mm	mm
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	0.	20 RE	F.
b	0.18	0.23	0.28
D	1	.60 BS	SC
E	1	.60 BS	SC
е	0	.50 BS	SC
L	0.19	0.24	0.29
K	0.20	_	-

PAD SIZE		E2		D2			
unit	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
E2XD2	mm	mm	mm	mm	mm	mm	
31X47 MIL	0.55	0.60	0.65	0.95	1.00	1.05	

■ DFN 1.6 x 1.6



# **Specifications**

### Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	VDD	-0.3	6	V
Negative Voltage Input	V <sub>VM</sub>	VDD-28	VDD+0.3	V
Charge FET Control	V <sub>COUT</sub>	VDD-28	VDD+0.3	V
Discharge FET Control	V <sub>DOUT</sub>	-0.3	VDD+0.3	V
Current Sense Input	Vcs	-0.3	VDD+0.3	V
Storage Temperature	T <sub>stg</sub>	-55	+125	°C

### Recommend Operating Condition

Parameter	Symbol	Min	Max	Unit
Operation Temperature	T <sub>opr</sub>	-40	+85	°C
Operating Voltage	V <sub>OP</sub>	1.5	5.5	V

### ESD Ratings

Parameter	Symbol	Value	Unit
Human Body Model	HBM	+-3500	V
Machine Model	MM	+-300	V
Charged Device Model	CDM	+-2000	V
Latch-up		+-300	mA

## **Product Name Structure**

- 1. Product Name
  - 1.1 DFN 1.6 x 1.6 x 0.75







# Product Line Up

# Detection/Release

Part Number	Features	Overcharge Detection Voltage	Overcharge Release Voltage	Overdischarge Detection Voltage	Overdischarge Release Voltage	Discharge Overcurrent Detection Voltage	Charge Overcurrent Detection Voltage	Load Short Circuit Detection Voltage	0V Battery Charge Inhibition Battery Voltage	0V Battery Charge Permission Battery Voltage	0V Battery Charge Inhibition Battery Voltage Enable/Disable	0V Battery Charge Permission Battery Voltage Enable/Disable	Overcharge Release Voltage Latch Enable/Disable	Overcharge Release Voltage Hysteresis Enable/Disable	Power Down Mode Enable/Disable
	Symbol	Vdet1	V <sub>det1Rel</sub>	Vdet2	$V_{det2Rel}$	Vdet3	Vdet4	Vshort	VOINH	VOCHG	VOINH	VOCHG	V <sub>det1RelEn</sub>	V <sub>det1RelHEn</sub>	Mpd
	Unit	v	v	v	v	mV	mV	mV	V	v					
SKPI3860N	ID00IAT0A	4.475	4.275	2.5	2.9	15	-15	33	0.9		enable	disable	disable	enable	disable

# Delay Times

Part Number	Features	Overcharge Detection Delay Time	Overcharge Release Delay Time	Overdischarge Detection Delay Time	Overdischarge Release Delay Time	Discharge Overcurrent Detection Delay Time	Discharge Overcurrent Release Delay Time	Charge Overcurrent Detection Delay Time	Charge Overcurrent Release Delay Time	Load Short Circuit Detection Delay Time
	Symbol	tVdet1	tV <sub>det1Rel</sub>	tVdet2	$tV_{det2Rel}$	tVdet3	tV <sub>det3Rel</sub>	tVdet4	$tV_{det4Rel}$	tVshort
	Unit	s	ms	ms	ms	ms	ms	ms	ms	us
SKPI3860N	MD00IAT0A	1.0	16	19	1.5	68	6	16	4.5	250



# Electrical Characteristic

Ta=25°C, unless otherwise noted

Parameter	Test Conditions	Min	Тур	Max	Unit
Current Consumption					
Inormal	$VDD=3.5V, V_{CS}=0V, V_{VM}=0V$		2.5	4	uA
I <sub>standby</sub>	VDD= 1.5V,V <sub>CS</sub> = 0V,V <sub>VM</sub> = 1.5V		1	1.5	uA
lpower_down	VDD= 1.5V,V <sub>CS</sub> = 0V,V <sub>VM</sub> = 1.5V			0.1	uA
Resistances					
R <sub>VMD :</sub> VM pin Pull-up resistance	VDD= 1.8V, V <sub>CS</sub> =0V, V <sub>VM</sub> =0V		312	624	kΩ
R <sub>VMS</sub> : VM pin Pull-down resistance	VDD= 3.5V, V <sub>CS</sub> =0V, V <sub>VM</sub> =1V		23	46	kΩ
R <sub>COH :</sub> COUT pin Pull-up resistance	VDD= 3.5V, V <sub>CS</sub> =0V, V <sub>VM</sub> =0V, V <sub>COUT</sub> =3V		4.5	9	kΩ
R <sub>COL :</sub> COUT pin Pull-down resistance	VDD= 4.5V, V <sub>CS</sub> =0V, V <sub>VM</sub> =0V, V <sub>COUT</sub> =3V		3.1	6.2	kΩ
R <sub>DOH</sub> : DOUT pin Pull-up resistance	VDD= 3.5V, V <sub>CS</sub> =0V, V <sub>VM</sub> =0V, V <sub>DOUT</sub> =3V		1.6	3.2	kΩ
R <sub>DOL</sub> : DOUT pin Pull-down resistance	VDD= 1.8V, V <sub>CS</sub> =0V, V <sub>VM</sub> =0V, V <sub>DOUT</sub> =0.5V		2.1	4.2	kΩ
R <sub>CS :</sub> CS pin Input resistance	VDD=3.5V, V <sub>CS</sub> =0.05V, V <sub>VM</sub> =0V		117	234	kΩ
<b>OV Battery Charge Permi</b>	ssion Function				
V <sub>0CHG</sub>		0.5	0.9	1.3	V
<b>OV Battery Charge Inhibi</b>	tion Function				
V <sub>OINH</sub>		0.5	0.9	1.3	v



# Battery Protection Accuracy

Ta=25°C, unless otherwise noted

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Overcharge Detection Voltage	Vdet1		-0.015	Vdet1	+0.015	v
Overcharge Release Voltage	V <sub>det1Rel</sub>		-0.020	V <sub>det1Rel</sub>	+0.020	v
Overdischarge Detection Voltage	Vdet2		-0.025	Vdet2	+0.025	v
Overdischarge Release Voltage	V <sub>det2Rel</sub>		-0.030	V <sub>det2Rel</sub>	+0.030	V
Discharge Overcurrent Detection Voltage (Expressed as the voltage across the resistor)	Vdet3		-0.001	Vdet3	+0.001	v
Discharge Overcurrent Release Voltage	V <sub>det3Rel</sub>	Release condition: VM voltage low than Discharge Overcurrent Release Voltage to release	-0.3	V <sub>det3Rel</sub>	+0.3	v
Charge Overcurrent Detection Voltage (Expressed as the voltage across the resistor)	Vdet4		-0.001	Vdet4	+0.001	v
Charge Overcurrent Release Voltage	V <sub>det4Rel</sub>	Release condition: VM voltage high than Charge Overcurrent Release Voltage to release	-0.1	V <sub>det4Rel</sub>	+0.1	v
Load Short Circuit Detection Voltage (Expressed as the voltage across the resistor)	Vshort		-0.005	Vshort	+0.005	v
Load Short Circuit Release Voltage	V <sub>SCRel</sub>	Release condition: VM voltage low than to Load Short Circuit Release Voltage release	-0.3	V <sub>SCRel</sub>	+0.3	v
0V Battery Charge Inhibition Battery Voltage	V <sub>OINH</sub>		-0.400	V <sub>OINH</sub>	+0.400	v
0V Battery Charge Permission Battery Voltage	V <sub>0CHG</sub>		-0.400	V <sub>OCHG</sub>	+0.400	v

# Battery Protection Detection & Release Delay Time Accuracy

		Ta=2	25°C, unle	ss otherw	vise not
Parameter	Symbol	Min	Тур	Max	Unit
Overcharge Detection Delay Time	tVdet1	-30%	tVdet1	+30%	s
Overcharge Release Delay Time	tV <sub>det1Rel</sub>	-30%	tV <sub>det1Rel</sub>	+30%	ms
Overdischarge Detection Delay Time	tVdet2	-30%	tVdet2	+30%	ms
Overdischarge Release Delay Time	tV <sub>det2Rel</sub>	-30%	tV <sub>det2Rel</sub>	+30%	ms
Discharge Overcurrent Detection Delay Time	tVdet3	-30%	tVdet3	+30%	ms
Discharge Overcurrent Release Delay Time	tV <sub>det3Rel</sub>	-30%	tV <sub>det3Rel</sub>	+30%	ms
Charge Overcurrent Detection Delay Time	tVdet4	-30%	tVdet4	+30%	ms
Charge Overcurrent Release Delay Time	tV <sub>det4Rel</sub>	-30%	tV <sub>det4Rel</sub>	+30%	ms
Load Short Circuit Detection Delay Time	tVshort	-50%	tVshort	+50%	us





# Battery Protection Threshold Options

Parameter	Symbol			Op	tions			Unit
Overcharge Detection Voltage	Vdet1	4.40	4.45	4.475	4.50	4.535	4.545	v
Overcharge Release Voltage	V <sub>det1Rel</sub>		Vdet1 -	0.2V		Vdet1		v
Overdischarge Detection Voltage	Vdet2	2.1		2.3	2.36	2.4	2.5	v
Overdischarge Release Voltage ( Must be over the Overdischarge Detection Voltage)	V <sub>det2Rel</sub>	2.3	2.4	2.5	2.6	2.7	2.9	v
Discharge Overcurrent Detection Voltage	Vdet3	17	15	13	11	9	7	mV
Discharge Overcurrent Release Voltage	scharge Overcurrent Release Voltage V <sub>det3Rel</sub> VDD-0.75				v			
Charge Overcurrent Detection Voltage	Vdet4	-19	-17	-15	-13	-11	-9	mV
Charge Overcurrent Release Voltage	V <sub>det4Rel</sub>			0	.25			v
Load Short Circuit Detection Voltage	Vshort	33			31		mV	
Load Short Circuit Release Voltage	V <sub>SCRel</sub>			VDD	0-0.75			v
0V Battery Charge Inhibition Battery Voltage	V <sub>OINH</sub>	V <sub>0INH</sub> 1.6		0.9		V		
0V Battery Charge Permission Battery Voltage	V <sub>OCHG</sub>	1.6 0.9			v			

Battery Protection Detection & Release Delay Time Option *1							
Parameter	Symbol	Option	Unit				
Overcharge Detection Delay Time	tVdet1	1.0	S				
Overcharge Release Delay Time	tV <sub>det1Rel</sub>	16	ms				
Overdischarge Detection Delay Time	tVdet2	19	ms				
Overdischarge Release Delay Time	tV <sub>det2Rel</sub>	1.5	ms				
Discharge Overcurrent Detection Delay Time	tVdet3	68	ms				
Discharge Overcurrent Release Delay Time	tV <sub>det3Rel</sub>	6	ms				
Charge Overcurrent Detection Delay Time	tVdet4	16	ms				
Charge Overcurrent Release Delay Time	tV <sub>det4Rel</sub>	4.5	ms				
Load Short Circuit Detection Delay Time	tVshort	250	us				

\*1: Current detection delay time option has only 1 option. To increase the options, please contact with Sales.

# Protection Mode Latch Enable Options

Parameter	Symbol	Optio	ns
Overcharge Release Voltage Latch Enable/Disable	V <sub>det1RelEn</sub>	Enable <sup>*1</sup>	Disable

\*1: When charge over voltage latch enabled, the overcharge control will be released when the battery voltage is lower than overcharge detection voltage and VM pin is higher than 0.25V.

## Hysteresis Enable Options

Parameter	Symbol	Options	
Overcharge Release Voltage Hysteresis Enable/Disable	V <sub>det1RelHEn</sub>	Enable	Disable



# Power Down Mode Options

Parameter	Symbol	Opti	ons
Power Down Mode Enable/Disable	M <sub>PD</sub>	Enable	Disable

## **Typical Application Circuits**



Symbol	Part	Min	Тур	Max	Unit	Purpose
R1	Resistor		100	1k	Ω	
R2	Resistor		1k	10k	Ω	For current limit of charger reverse connection
R-Sense	Resistor					
C1	Capacitor	0.01	0.1	1	uF	For Input Voltage Stability
C2	Capacitor		0.1		uF	For Noise Suppression



### **Test Circuits**

Based on different test items, the test circuits are different and shown as below. COUT pin and DOUT pin are used as control pins to turn on or turn off the external charge and discharge MOSFETs. When COUT pin or DOUT pin is output "L", the external MOSFET is turned off. The charge or discharge paths are cut off. At this time, charging or discharging the battery is not allowed. When the abnormal situation is released, the COUT pin or DOUT pin will output "H" to turn on the MOSFET to allow the battery to be charged or discharged. Initially, the COUT and DOUT pins are output "H" to ensure the battery can be charged or discharged. VDD pin in the test circuit can be treated as battery voltage.

#### 1. Overcharge detection and release

The overcharge detection voltage is measured by the test

circuit 1 as shown on the right.

Test steps :

- 1. Set VDD voltage to 3.60V and CS to 0V.
- 2. Increase VDD voltage gradually.
- When the voltage on VDD is increased, exceeds the Vdet1 detection voltage and the detection delay time (tVdet1) expired, COUT pin will transition from "H" to "L".
- 4. At this moment, enter the charging overvoltage protection state.
- 5. Then test charging overvoltage release measurement
- 6. Decrease VDD voltage gradually.
- 7. When the voltage on VDD changes and is lower than  $V_{det1Rel}$  and the delay time expired  $tV_{det1Rel}$ , COUT pin will transition from "L" to "H".
- 8. There are two conditions as below.
  - 8.1 System connects load :

When the battery voltage is lower than Vdet1 and VM pin voltage is higher than 0.25V(typical) and the delay time expired  $tV_{det1Rel}$ , overcharge condition is released.

8.2 Charger remove :

When the battery voltage is lower than  $V_{det1Rel}$  and VM pin voltage is lower than 0.25V(typical) and the delay time expired  $tV_{det1Rel}$ , overcharge condition is released.



Test Circuit 1



#### 2. Overdischarge detection and release

The overdischarge detection voltage is measured by the

- test circuit 2 as shown on the right. Test steps:
- 1. Set VDD voltage to 3.60V and CS=VM to 0V.
- 2. Decrease VDD voltage gradually.
- 3. When the voltage on VDD is decreased, goes lower than the Vdet2 detection voltage and the detection delay time (tVdet2) expired, DOUT pin will transition from "H" to "L".
- 4. At this moment, enter the discharge overvoltage protection state.
- 5. Then test discharge overvoltage release measurement.
- 6. Increase VDD voltage gradually.
- 7. When the voltage on VDD changes and goes higher than  $V_{det2Rel}$  and the delay time expired  $tV_{det2Rel}$ , DOUT pin will transition from "L" to "H".
- 8. At this moment, the discharge overvoltage protection state is released.

#### 3. Discharge overcurrent detection and release

The discharge overcurrent detection is measured by the test circuit 2 as shown on the right.

Test steps:

- 1. Set VDD voltage to 3.60V and CS=VM to 0V.
- 2. Increase CS voltage gradually.
- When the voltage on CS pin is increased and the voltage V<sub>CS</sub> is higher than VSS plus Vdet3 and the detection delay time (tVdet3) expired, DOUT pin will transition from "H" to "L".
- 4. At this moment, enter the discharge overcurrent protection state.
- 5. Then test discharge overcurrent release measurement.
- 6. Set  $V_{CS}$ =0V,  $V_{VM}$ =3.60V
- 7. Decrease VM voltage gradually.
- 8. For release condition : When the VM pin voltage is lower than  $V_{det3Rel}$  and the release delay time expired  $tV_{det3Rel}.$
- 9. Discharge overcurrent condition is released.
- 10. The relation between VM and Rload is shown as following :

V<sub>VM</sub>=VDD X R<sub>VMS</sub>/(R<sub>VMS</sub>+Rload)



### **Test Circuit 2**



**Test Circuit 2** 





### 4. Charge overcurrent detection and release

The charge overcurrent detection is measured by the test circuit 2 as shown on the right.

Test steps:

- 1. Set VDD voltage to 3.60V and CS=VM to 0V
- 2. Decrease CS voltage gradually.
- 3. When the voltage on CS pin is decreased and the voltage  $V_{CS}$  is lower than VSS plus Vdet4 and the detection delay time (tVdet4) expired, COUT pin will transition from "H" to "L".
- 4. At this moment, enter the charging overcurrent protection state.
- 5. Then test charging overcurrent release measurement.
- 6. Set V<sub>CS</sub>=0V
- 7. Increase VM voltage gradually.
- 8. For release condition : When the charger is removed, the system connects load, VM pin voltage is higher than  $V_{det4Rel}$  and the release delay time expired  $tV_{det4Rel}$ . COUT pin will transition from "L" to "H".
- 9. Charge overcurrent condition is released.

#### 5. Load short circuit detection and release

The load short circuit detection is measured by the test circuit 2 as shown on the right.

Test steps:

- 1. Set VDD voltage to 3.60V and CS=VM to 0V
- 2. Increase CS voltage gradually.
- 3. When the voltage on CS pin is increased and the voltage  $V_{CS}$  is higher than Vshort, before the detection delay time (tVshort) is expired, the voltage  $V_{CS}$  keeps on increase to be higher than VSS plus Vshort and the detection delay time (tVshort) expired, DOUT pin will transition from "H" to "L".
- 4. At this moment, enter the short-circuit overcurrent protection state.
- 5. Then test short-circuit overcurrent release measurement.
- 6. Set  $V_{CS}$ =0V,  $V_{VM}$ =3.60V
- 7. Decrease VM voltage gradually.
- 8. When the VM pin voltage is lower than  $V_{SCRel}$ , DOUT pin will transition from "L" to "H".
- 9. Load short circuit condition is released.
- 10. The relation between VM and Rload is shown as following :
  - V<sub>VM</sub>=VDD X R<sub>VMS</sub>/(R<sub>VMS</sub>+Rload)



Test Circuit 2



**Test Circuit 2** 



#### 6. Power consumption in normal operation mode

The normal mode power consumption is measured by the test circuit 2 as shown on the right.

- Test steps :
- . 1. Set VDD =3.50V
- 2. Set V<sub>CS</sub>=V<sub>VM</sub>=0V
- 3. COUT and DOUT floating.
- 4. Then measure the current Inormal going into VDD pin.
- 5. Get the power consumption of normal mode  $\mathsf{I}_{\mathsf{normal}}$

#### 7. Power consumption in standby mode

The standby mode power consumption is measured by the test circuit 2 as shown on the right.

Test steps :

- 1. Set VDD= $V_{VM}$ =1.50V
- 2. Set V<sub>cs</sub>=0V
- 3. COUT and DOUT floating.
- 4. Then measure the current  $I_{\mbox{standby}}$  going into VDD pin.
- 5. Get The power consumption of standby mode  $I_{standby}$ .

#### 8. Pull-up resistance between VDD to VM pin ( $R_{VMD}$ )

The pull-up resistance between VDD and VM pin is measured by the test circuit 3 as shown on the right. Test steps:

- 1. Set VDD=1.80V
- 2. Set V<sub>CS</sub>=V<sub>VM</sub>=0V
- 3. COUT and DOUT floating.
- 4. Then measure the current  $I_{VM.}$
- 5. The pull-up resistance between VDD and VM pin is obtained by the relation :

R<sub>VMD</sub>=VDD/I<sub>VM</sub>

#### 9. Pull-down resistance between VM to VDD pin ( $R_{VMS}$ )

The pull-down resistance between VDD and VM pin is measured by the test circuit 3 as shown on the right.

#### Test steps:

- 1. Set VDD=3.50V
- $2. \quad Set \ V_{CS} = 0 V$
- 3. Set  $V_{VM}$ =1.0V
- 4. COUT and DOUT floating.
- 5. Then measure the current  $I_{\text{VM.}}$
- The pull-down resistance between VDD and VM pin is obtained by the relation :

 $R_{VMS} = V_{VM} / I_{VM}$ 







Test Circuit 2



**Test Circuit 3** 



Test Circuit 3



#### 10. COUT pin pull-up resistance (R<sub>COH</sub>)

The pull-up resistance on COUT pin is measured by

the test circuit 4 as shown on the right.

Test steps :

- 1. Set VDD=3.50V
- 2. Set V<sub>CS</sub>=V<sub>VM</sub>=0V
- 3. Set V<sub>COUT</sub>=3.0V
- 4. DOUT floating
- 5. Then measure the current  $I_{COUT}$ .
- 6. The COUT pin pull-up resistance is obtained by the relation :

R<sub>COH</sub>=(VDD-V<sub>COUT</sub>)/I<sub>COUT</sub>

#### 11. COUT pin pull-down resistance (R<sub>COL</sub>)

The pull-down resistance on COUT pin is measured by the test circuit 4 as shown on the right.

Test steps :

- 1. Set VDD=4.50V
- 2. Set V<sub>CS</sub>=V<sub>VM</sub>=0V
- 3. Set V<sub>COUT</sub>=3.0V
- 4. DOUT floating
- 5. Then measure the current I<sub>COUT</sub>.
- 6. The COUT pin pull-down resistance is obtained by the relation :

RCOL=VCOUT/ ICOUT

#### 12. DOUT pin pull-up resistance (R<sub>DOH</sub>)

The pull-up resistance on DOUT pin is measured by

the test circuit 4 as shown on the right.

Test steps :

- 1. Set VDD=3.50V
- 2. Set V<sub>CS</sub>=V<sub>VM</sub>=0V
- 3. Set V<sub>DOUT</sub>=3.0V
- 4. COUT floating.
- 5. Then measure the current IDOUT.
- 6. The DOUT pin pull-up resistance is obtained by the relation:

R<sub>DOH</sub>=(VDD-V<sub>DOUT</sub>)/I<sub>DOUT</sub>







**Test Circuit 4** 







#### 17. Overcharge detection delay time (tVdet1)

The overcharge detection delay time is measured by

the test circuit 5 as shown on the right.

Test steps:

- 1. Set VDD=3.50V
- 2. Set  $V_{CS}=V_{VM}=0V$
- 3. DOUT floating
- 4. Then monitor COUT pin whether transition from "H" to "L".
- 5. Increase the VDD voltage. When VDD voltage exceeds the Vdet1 detection threshold, the internal delay time counter starts to count. When the internal delay time counts exceeds the tVdet1, COUT pin will transition from "H" to "L".
- tVdet1 equals to the time period between VDD voltage exceeds Vdet1 and COUT transitions from "H" to "L".

#### 18. Overdischarge detection delay time (tVdet2)

The overdischarge detection delay time is measured by the test circuit 5 as shown on the right.

- Test steps:
- 1. Set VDD=3.50V
- 2. Set  $V_{CS}=V_{VM}=0V$
- 3. COUT floating
- 4. Then monitor DOUT pin whether transition from "H" to "L".
- Decrease the VDD voltage. When VDD voltage goes lower than the Vdet2 detection threshold, the internal delay time counter starts to count. When the internal delay time counts exceeds the tVdet2, DOUT pin will transition from "H" to "L".
- tVdet2 equals to the time period between VDD voltage goes lower than Vdet2 and DOUT transitions from "H" to "L".









#### 19. Discharge overcurrent detection delay time (tVdet3)

The discharge overcurrent detection delay time is measured by the test circuit 5 as shown on the right.

- Test steps:
- 1. Set VDD=3.50V
- 2. Set  $V_{CS}=V_{VM}=0V$
- 3. COUT floating.
- 4. Then monitor DOUT pin whether transition from "H" to "L".
- 5. Increase the  $V_{CS}$  voltage. When  $V_{CS}$  voltage exceeds the Vdet3 detection threshold, the internal delay time counter starts to count. When the internal delay time counts exceeds the tVdet3, DOUT pin will transition from "H" to "L".
- 6. tVdet3 equals to the time period between  $V_{CS}$  voltage exceeds Vdet3 and DOUT transitions from "H" to "L".

#### 20. Charge overcurrent detection delay time (tVdet4)

The charge overcurrent detection delay time is measured by the test circuit 5 as shown on the right.

Test steps :

- 1. Set VDD=3.50V
- 2. Set  $V_{CS}=V_{VM}=0V$
- 3. DOUT floating.
- 4. Then monitor COUT pin whether transition from "H" to "L".
- 5. Decrease the  $V_{CS}$  voltage. When  $V_{CS}$  voltage goes lower than the Vdet4 detection threshold, the internal delay time counter starts to count. When the internal delay time counts exceeds the tVdet4, COUT pin will transition from "H" to "L".
- 6. tVdet4 equals to the time period between  $V_{CS}$  voltage goes lower than Vdet4 and COUT transitions from "H" to "L".

#### 21. Load short circuit detection delay time(tVshort)

The load short circuit detection delay time is measured by the test circuit 5 as shown on the right.

Test steps:

- 1. Set VDD=3.50V
- 2. Set V<sub>CS</sub>=V<sub>VM</sub>=0V
- 3. COUT floating.
- 4. Then monitor DOUT pin whether transition from "H" to "L".
- 5. Increase the  $V_{CS}$  voltage. When  $V_{CS}$  voltage exceeds the Vshort detection threshold, the internal delay time counter starts to count. When the internal delay time counts exceeds the tVshort, DOUT pin will transition from "H" to "L".
- 6. tVshort equals to the time period between  $V_{CS}$  voltage exceeds Vshort and DOUT transitions from "H" to "L".





**Test Circuit 5** 





# **Product Series Specification Option**

SKPI38	60MD F	use Tri	m at CP	stage (	Option				
Features	Overcharge Detection Voltage	Overdischarge Detection Voltage	Overdischarge Release Voltage (Must be over Overdischarge Detection Voltage)	Discharge Overcurrent Detection Voltage	Charge Overcurrent Detection Voltage	Load Short Circuit Detection Voltage	Overcharge Release Voltage Latch Enable/Disable	Overcharge Release Voltage Hysteresis Enable/Disable	Power Down Mode Enable/Disable
Symbol	Vdet1	Vdet2	V <sub>det2Rel</sub>	Vdet3	Vdet4	Vshort	V <sub>det1RelEn</sub>	V <sub>det1RelHEn</sub>	M <sub>PD</sub>
Unit	v	v	v	mV	mV	mV			
	4.400	2.10	2.3	7	-9	31	disable	disable	disable
	4.450	2.30	2.4	9	-11	33	enable	enable	enable
	4.475	2.36	2.5	11	-13				
Value	4.500	2.40	2.6	13	-15				
	4.535	2.50	2.7	15	-17				
	4.545		2.9	17	-19				
				19	-21				

SKPI386	50MD	Metal O	ption at	t Photo
Features	<b>OV Battery Charge Inhibition Battery Voltage</b>	0V Battery Charge Permission Battery Voltage	0V Battery Charge Inhibition Battery Voltage Enable/Disable	0V Battery Charge Permission Battery Voltage Enable/Disable
Symbol	VOINH	VOCHG	VOINH	Vochg
Unit	v	v		
Value	1.6	1.6	disable	disable
value	0.9	0.9	enable	enable

The options in yellow color are for current SKPI3860MD00IAT0A version.